

## Wafer Materials Composition Sheet

Name for components	Category for Components	Specifications Description	Materials Composition
MUDP	Electronic components	Integrated circuit chip	Electronic components
Envelop	Plastic components	It is made in polycarbonate and it is transparent for the card itself	PC material
Needle	Meatal components	It is made in stainless steel and it is used to make the function of rotating	stainless steel
Locking buckle	Meatal components	It is made in brass and it's used to fix the position for the needle	Brass
Print paper	paper materials	Copper printing paper	Paper
Cold lamination film	PET materials	It's used to cover the surface to protect the print paper	PET
double-side tapes	tape	It's used to stick the MUDP on the trap	Acrylic base